

MS IF
REPLY UNDER 37 C.F.R. § 1.312
EXPEDITED PROCEDURE
EXAMINING GROUP 1712
PATENT
0171-0759P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

Shoichi OSADA et al.

Conf.:

9440

Appl. No.:

09/883,276

Group:

1712

Filed:

June 19, 2001

Examiner:

Marc ZIMMER

For:

SEMICONDUCTOR ENCAPSULATING EPOXY RESIN

COMPOSITION AND SEMICONDUCTOR DEVICE

or to enter

AMENDMENT UNDER 37 CFR 1.312

HANDCARRY TO:

March 19, 2004

U.S. Patent and Trademark Office 2011 South Clark Place Customer Window Crystal Plaza Two, Lobby, Room 1B03 Arlington, VA 22202

Sir:

The following amendments and Remarks are respectfully submitted in connection with the above-identified application.

This Paper includes:

Amended Claim Set; and

Remarks.